## **AMENDMENTS TO CLAIMS**

- 1. (currently amended) A process for measuring stress on a conducting surface having an insulating coating applied to said surface and a conductive coating applied to said insulating coating, the process comprising measuring a change in the resistivity of said conductive coating, wherein said conductive coating comprises stabilized diamond-like metal-carbon atomic scale composites having a concentration of metal that exhibits conductivity percolation with an applied stress.
- 2. (canceled)
- 3. (new) A stress sensor system comprising at least one stress sensor, wherein the sensor comprises:
  - a first electrode;
  - at least one other electrode; and
- a sensing film disposed in relation to the first and the at least one other electrode for determining a change in resistivity of the sensing film, wherein the sensing film comprises a diamond-like metal-carbon atomic scale material having a concentration of metal for the material to exhibit conductivity percolation with an applied stress.
- 4. (new) The stress sensor system of claim 3, wherein the diamond-like metal-carbon material is a stabilized diamond-like metal-carbon composite.
- 5. (new) The stress sensor system of claim 4, wherein the diamond-like metal-carbon material is stabilized with silica.
- 6. (new) The stress sensor system of claim 3, wherein the diamond-like metal-carbon material comprises a metal selected from the group consisting of Cr, Ni, Fe, Co, Mo, W, Nb, Ta, Ti, V, Mn, Re, and Hf.
- 7. (new) The stress sensor system of claim 3, wherein the concentration of the metal of the diamond-like metal-carbon is up to about 50%.
- 8. (new) The stress sensor system of claim 3, wherein the concentration of the metal of the diamond-like metal-carbon is about 25%.
- 9. (new) The stress sensor system of claim 3, wherein the diamond-like metal-carbon is free of phases greater than about 30 nanometers.

- 10. (new) The stress sensor system of claim 3, wherein the diamond-like metal-carbon material comprises a pre-percolation metal composition for sensing compressive stress.
- 11. (new) The stress sensor system of claim 3, wherein the diamond-like metal-carbon material comprises a post-percolation metal composition for sensing tensile stress.
- 12. (new) The stress sensor system of claim 3, wherein the diamond-like metal-carbon material comprises a middle-percolation metal composition for sensing at least one of compressive and tensile stress.
- 13. (new) The stress sensor system of claim 3, wherein the sensing film is adhered to a substrate to be monitored for stress.
- 14. (new) The stress sensor system of claim 13, wherein the substrate is electrically conductive and wherein a dielectric film is adhered to the substrate and the sensing film is adhered to the dielectric film.
- 15. (new) The stress sensor system of claim 13, wherein the sensing film is adhered to the substrate by depositing the sensing film on the substrate using a deposition process.
- 16 (new) The stress sensor system of claim 15, comprising a plurality of stress sensors, wherein the sensing film of each of the plurality of stress sensors is cut from a sensing layer deposited onto the substrate.
- 17. (new) The stress sensor system of claim 15, wherein the first and the at least one other electrode are formed by depositing a conducting layer over the sensing film using a mask with contact areas over the sensing film exposed.
- 18. (new) The stress sensor system of claim 15, wherein the stress sensor comprises a dielectric stabilized diamond-like carbon layer deposited over the stress sensor.
- 19. (new) A stress sensor system comprising at least one stress sensor, wherein the sensor comprises:
  - a first electrode;
  - at least one other electrode; and
- a sensing film disposed in relation to the first and the at least one other electrode for determining a change in resistivity of the sensing film, wherein the sensing film comprises a silica stabilized diamond-like metal-carbon atomic scale material having a concentration of

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metal for the material to exhibit conductivity percolation with an applied stress, and wherein the sensing film is deposited onto to a substrate to be monitored for stress.

19. (new) A stress sensor system comprising at least one stress sensor, wherein the sensor comprises:

a first electrode;

at least one other electrode; and

a sensing film disposed in relation to the first and the at least one other electrode for determining a change in resistivity of the sensing film, wherein the sensing film comprises a diamond-like metal-carbon atomic scale material having one of:

a pre-percolation metal composition for sensing compressive stress;

a post-percolation metal composition for sensing tensile stress; and

a middle-percolation metal composition for sensing at least one of compressive and tensile stress.

- 21. (new) The stress sensor system of claim 20, comprising a plurality of stress sensors, wherein the sensing film of each of the plurality of stress sensors is cut from a sensing layer deposited onto a substrate to be monitored for stress.
- 22. (new) The stress sensor system of claim 21, wherein a substrate is electrically conductive and a dielectric layer is deposited over the substrate and the sensing layer is deposited over dielectric layer.